



BR25G512FJ-3GE2 Information



For Reference Only

Part Number BR25G512FJ-3GE2

Manufacturer Rohm Semiconductor

Category Integrated Circuits (ICs)

Memory

Description SPI BUS EEPROM

Package 8-SOIC (0.154", 3.90mm Width)

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









BR25G512FJ-3GE2 Specifications

Manufacturer Part Number	BR25G512FJ-3GE2
Manufacturer	Rohm Semiconductor
Category	Integrated Circuits (ICs)
	Memory
Package	8-SOIC (0.154", 3.90mm Width)
Series	-
Memory Type	Non-Volatile
Memory Format	EEPROM
Technology	EEPROM
Memory Size	512Kb (64K x 8)
Memory Interface	SPI
Clock Frequency	10MHz
Write Cycle Time - Word, Page	5ms
Access Time	-
Voltage - Supply	1.8 V ~ 5.5 V
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.154", 3.90mm Width)
Supplier Device Package	8-SOP-J
	Report errors?

BR25G512FJ-3GE2 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

BR25G512FJ-3GE2 Payment Methods



















BR25G512FJ-3GE2 Shipping Methods













If you have any question about BR25G512FJ-3GE2, please do not hesitate to contact us!

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